# **EcoSPARK<sup>®</sup> 3 Ignition IGBT**

# 270 mJ, 360 V, N-Channel Ignition IGBT

#### Features

- SCIS Energy = 270 mJ at  $T_J = 25^{\circ}C$
- Logic Level Gate Drive
- Low Saturation Voltage
- RoHS Compliant
- AEC-Q101 Qualified and PPAP Capable

#### Applications

- Automotive Ignition Coil Driver Circuits
- High Current Ignition System
- Coil on Plug Applications

#### **MAXIMUM RATINGS** (T<sub>J</sub> = $25^{\circ}$ C unless otherwise stated)

| Symbol                           | Parameter  | Value       | Units |  |
|----------------------------------|--|-------------|-------|--|
| BV <sub>CER</sub>                | Collector-to-Emitter Breakdown<br>Voltage (I <sub>C</sub> = 1 mA)                              | 360         | V     |  |
| BV <sub>ECS</sub>                | Emitter-to-Collector Voltage – Reverse<br>Battery Condition (I <sub>C</sub> = 10 mA)           | 28          | V     |  |
| E <sub>SCIS25</sub>              | ISCIS = 13.4 A, L = 3.0 mHy, R <sub>GE</sub> = 1 K $\Omega$<br>T <sub>C</sub> = 25°C (Note 1)  | 270         | mJ    |  |
| E <sub>SCIS150</sub>             | ISCIS = 10.8 A, L = 3.0 mHy, R <sub>GE</sub> = 1 K $\Omega$<br>T <sub>C</sub> = 150°C (Note 2) | 170         | mJ    |  |
| I <sub>C25</sub>                 | Collector Current Continuous at $V_{GE}$ = 5.0 V, $T_{C}$ = 25°C                               | 37.5        | A     |  |
| I <sub>C110</sub>                | Collector Current Continuous<br>at V <sub>GE</sub> = 5.0 V, T <sub>C</sub> = 110°C             | 24.3        | A     |  |
| V <sub>GEM</sub>                 | Gate-to-Emitter Voltage Continuous   | ±10         | V     |  |
| PD                               | Power Dissipation Total, $T_C = 25^{\circ}C$   | 150         | W     |  |
|                                  | Power Dissipation Derating, $T_C > 25^{\circ}C$  | 1.1         | W/°C  |  |
| T <sub>J</sub> /T <sub>STG</sub> | Operating Junction and Storage<br>Temperature Range  | -40 to +175 | °C    |  |
| ΤL                               | Lead Temperature for Soldering Purposes (1/8" from case for 10 s)                              | 300         | °C    |  |
| T <sub>PKG</sub>                 | Reflow soldering according to JESD020C   | 260         | °C    |  |
| ESD                              | HBM – Electrostatic Discharge Voltage at 100 pF, 1500 $\Omega$                                 | 4           | kV    |  |
|                                  | CDM – Electrostatic Discharge Voltage at 1 $\Omega$  | 2           | kV    |  |

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

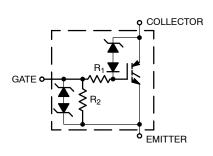
1. Self clamped inductive Switching Energy (ESCIS25) of 270 mJ is based on the test conditions that is starting  $T_J = 25^{\circ}C$ , L = 3 mHy, ISCIS = 13.4 A, VCC = 100 V during inductor charging and VCC = 0 V during time in clamp.

 Self Clamped inductive Switching Energy (ESCIS150) of 170 mJ is based on the test conditions that is starting T<sub>J</sub> = 150°C, L = 3mHy, ISCIS = 10.8 A, VCC = 100 V during inductor charging and VCC = 0 V during time in clamp.



## **ON Semiconductor®**

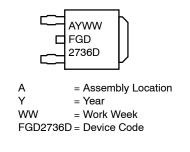
#### www.onsemi.com





DPAK (SINGLE GAUGE) CASE 369C

#### MARKING DIAGRAM



#### **ORDERING INFORMATION**

See detailed ordering and shipping information on page 2 of this data sheet.

#### THERMAL RESISTANCE RATINGS

| Characteristic                          | Symbol | Мах | Units |
|---|--------|-----|-------|
| Junction-to-Case – Steady State (Drain) |        | 1.1 | °C/W  |

#### **ELECTRICAL CHARACTERISTICS** (T<sub>J</sub> = 25°C unless otherwise specified)

| Symbol               | Parameter                               | Test Conditions  |                      | Min  | Тур  | Max  | Units |
|----------------------|---|--|----------------------|------|------|------|-------|
| OFF CHARA            | ACTERISTICS                             |  |                      |      |      |      |       |
| BV <sub>CER</sub>    | Collector-to-Emitter Breakdown Voltage  | $ I_{CE} = 2 \text{ mA}, V_{GE} = 0 \text{ V}, \\ R_{GE} = 1  k\Omega, T_{J} = -40 \text{ to } 150^{\circ}\text{C} $ |                      | 330  | _    | 390  | V     |
| BV <sub>CES</sub>    | Collector-to-Emitter Breakdown Voltage  | $    I_{CE} = 10 \text{ mA}, V_{GE} = 0 \text{ V}, \\ R_{GE} = 0, T_J = -40 \text{ to } 150^\circ\text{C} $          |                      | 350  | -    | 410  | V     |
| BV <sub>ECS</sub>    | Emitter-to-Collector Breakdown Voltage  | $I_{CE}$ = -75 mA, $V_{GE}$ = 0 V,<br>T <sub>J</sub> = 25°C  |                      | 28   | -    | _    | V     |
| BV <sub>GES</sub>    | Gate-to-Emitter Breakdown Voltage       | $I_{GES} = \pm 2 \text{ mA}$   |                      | ±11  | ±14  | -    | V     |
| I <sub>CER</sub>     | Collector-to-Emitter Leakage Current    | V <sub>CE</sub> = 175 V  | $T_J = 25^{\circ}C$  | -    | -    | 25   | μA    |
|                      |   | $R_{GE} = 1 \ k\Omega$   | $T_J = 150^{\circ}C$ | -    | -    | 1    | mA    |
| I <sub>ECS</sub>     | Emitter-to-Collector Leakage Current    | V <sub>EC</sub> = 24 V   | $T_J = 25^{\circ}C$  | -    | -    | 1    | mA    |
|                      |   |  | $T_J = 150^{\circ}C$ | -    | _    | 40   |       |
| R <sub>1</sub>       | Series Gate Resistance                  |  |                      | -    | 110  | _    | Ω     |
| R <sub>2</sub>       | Gate-to-Emitter Resistance              |  |                      | 10K  | -    | 30K  | Ω     |
| N CHARAG             | CTERISTICS                              |  |                      |      |      |      |       |
| V <sub>CE(SAT)</sub> | Collector-to-Emitter Saturation Voltage | $I_{CE} = 6 \text{ A}, \text{ V}_{GE} = 4 \text{ V}, \text{ T}_{J} = 25^{\circ}\text{C}$                             |                      | -    | 1.25 | 1.35 | V     |
| V <sub>CE(SAT)</sub> | Collector-to-Emitter Saturation Voltage | $I_{CE}$ = 10 A, $V_{GE}$ = 4.5 V, $T_{J}$ = 25°C  |                      | -    | 1.45 | 1.65 | V     |
| V <sub>CE(SAT)</sub> | Collector-to-Emitter Saturation Voltage | $I_{CE}$ = 10 A, $V_{GE}$ = 4.5 V, $T_{J}$ = 150°C   |                      | -    | 1.60 | 1.80 | V     |
| YNAMIC C             | HARACTERISTICS                          |  |                      |      |      |      |       |
| Q <sub>G(ON)</sub>   | Gate Charge                             | $I_{CE}$ = 10 A, $V_{CE}$ = 12 V, $V_{GE}$ = 5 V   |                      | -    | 18   | -    | nC    |
| V <sub>GE(TH)</sub>  | Gate-to-Emitter Threshold Voltage       | I <sub>CE</sub> = 1 mA   | $T_J = 25^{\circ}C$  | 1.3  | 1.6  | 2.2  | V     |
|                      |   | $V_{CE} = V_{GE}$ $T_J = 150^{\circ}C$   |                      | 0.75 | 1.1  | 1.8  | 1     |

#### SWITCHING CHARACTERISTICS

 $V_{\text{GEP}}$ 

| td <sub>(ON)R</sub>  | Current Turn-On Delay Time-Resistive  | $V_{CE} = 14 \text{ V}, \text{ R}_{\text{L}} = 1 \Omega, \text{ V}_{\text{GE}} = 5 \text{ V},$ | _ | 0.9 | 4  | μs |
|----------------------|---------------------------------------|--|---|-----|----|----|
| t <sub>rR</sub>      | Current Rise Time-Resistive           | R <sub>G</sub> = 470 Ω, T <sub>J</sub> = 25°C  | - | 3.0 | 7  |    |
| td <sub>(OFF)L</sub> | Current Turn-Off Delay Time-Inductive | $V_{CE} = 300 \text{ V}, \text{ L} = 1 \text{ mH}, \text{ V}_{GE} = 5 \text{ V},$              | - | 4.4 | 15 |    |
| t <sub>fL</sub>      | Current Fall Time-Inductive           | $R_{G}$ = 470 Ω, $I_{CE}$ = 6.5 A, $T_{J}$ = 25°C  | - | 1.9 | 15 |    |

V<sub>CE</sub> = 12 V, I<sub>CE</sub> = 10 A

3.0

V

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

#### PACKAGE MARKING AND DEVICE ORDERING INFORMATION

Gate-to-Emitter Plateau Voltage

| Device Marking | Device          | Package        | Reel Diameter | Tape Width | Qty† |
|----------------|-----------------|----------------|---------------|------------|------|
| FGD2736G3      | FGD2736G3-F085V | DPAK (Pb-Free) | 330 mm        | 16 mm      | 2500 |

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

#### **TYPICAL CHARACTERISTICS**

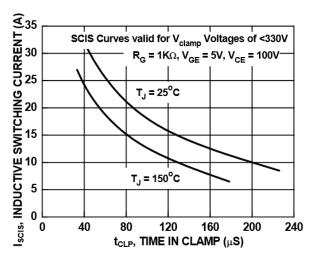
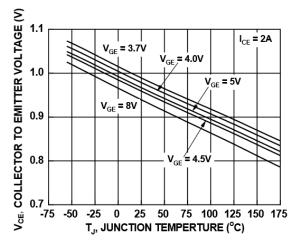
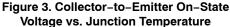


Figure 1. Self Clamped Inductive Switching Current vs. Time in Clamp





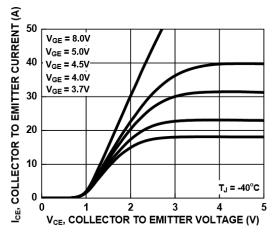
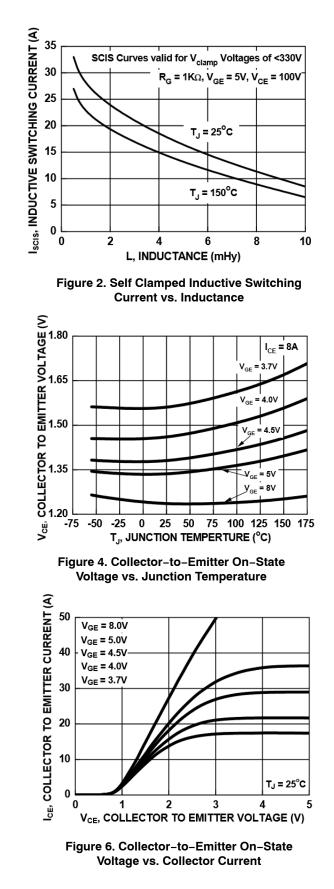
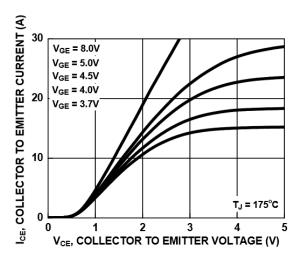


Figure 5. Collector-to-Emitter On-State Voltage vs. Collector Current



#### **TYPICAL CHARACTERISTICS**





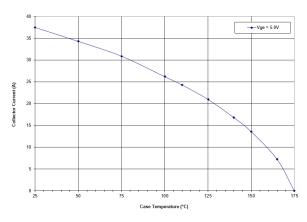


Figure 9. Current Derating

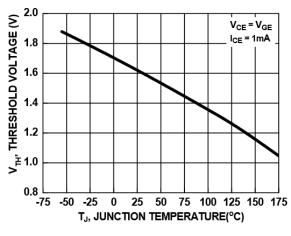


Figure 11. Threshold Voltage vs. Junction Temperature

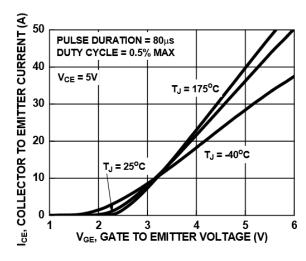


Figure 8. Transfer Characteristics

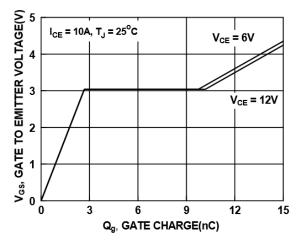
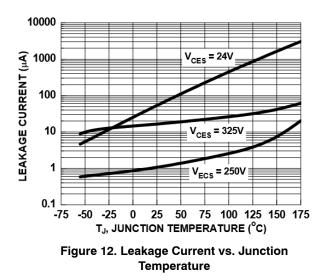


Figure 10. Gate Charge



#### **TYPICAL CHARACTERISTICS**

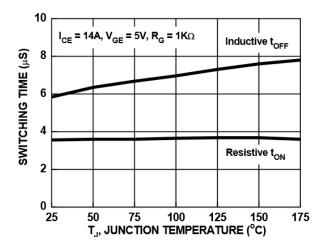


Figure 13. Switching Time vs. Junction Temperature

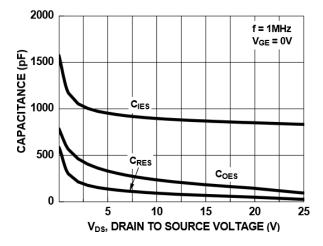


Figure 14. Capacitance vs. Collector-to-Emitter Voltage

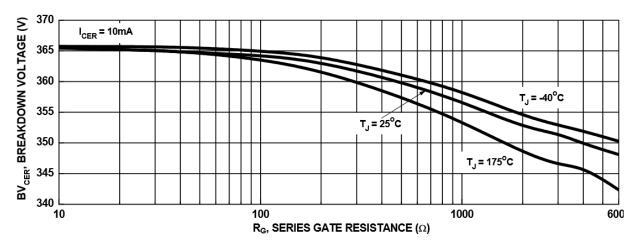
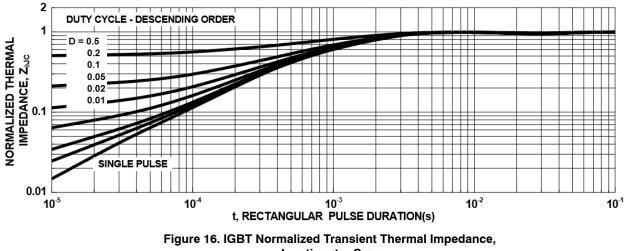


Figure 15. Break Down Voltage vs. Series Resistance



Junction-to-Case

#### **TEST CIRCUITS AND WAVEFORMS**

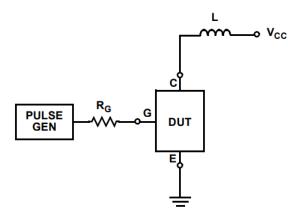


Figure 17. Inductive Switching Test Circuit

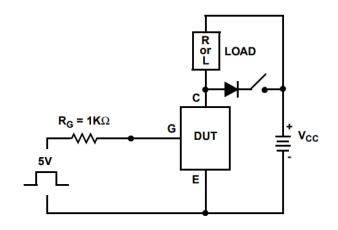


Figure 18.  $t_{\text{ON}}$  and  $t_{\text{OFF}}$  Switching Test Circuit

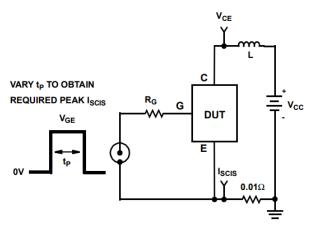


Figure 19. Energy Test Circuit

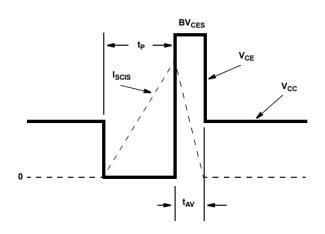
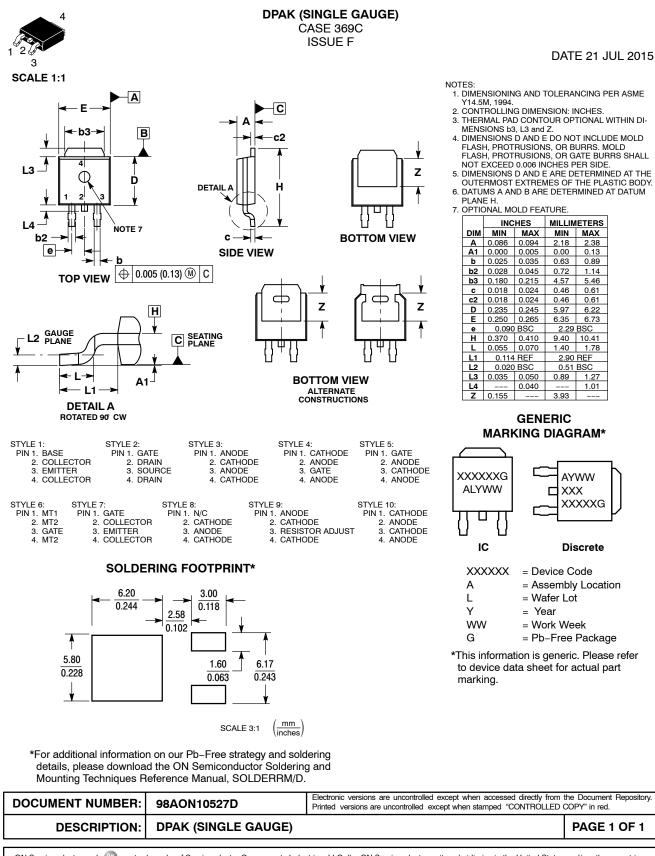


Figure 20. Energy Waveforms

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